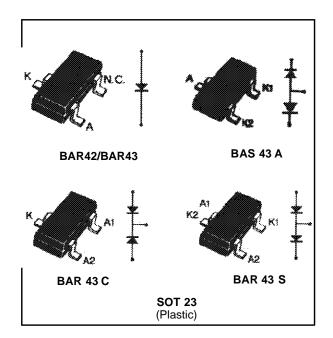
BAR 42 BAR 43, A, C, S

SMALL SIGNAL SCHOTTKY DIODES



DESCRIPTION

General purpose metal to silicon diodes featuring very low turn-on voltage and fast switching.

ABSOLUTE RATINGS (limiting values) (T_{amb} = 25°C) (see note 1)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	30	V
l _F	Forward Current	100	mA
IFRM	Repetitive Peak Fordware Current	350	mA
I _{FSM}	Surge non Repetitive Forward Current	750	Α
P _{tot}	Power Dissipation* (see note 2)	160	mW
T _{stg} T _j	Storage and Junction Temperature Range	- 55 to + 150 - 55 to + 125	°C

THERMAL RESISTANCE (see note 3)

Symbol	Test Conditions	Value	Unit
R _{th (j-a)}	Junction-ambient*	625	°C/W
R _{th(j-SR)}	Junction-substrate	400	°C/W

^{*} Mounted on ceramic substrate: 7 x 5 x 0.5mm.

Notes: 1 For double diodes maximum ratings apply to each diode, provided that rated Ptot is not exceeded.

2 For double diodes Ptot is the total power dissipation of the two diodes.

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³ For double diodes, Rth refer to the total power dissipation in the two diodes and is given independently of the power distribution in the two diodes.

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Symbol	Test Conditions			Min.	Тур.	Max.	Unit
V_{BR}	Tamb = 25°C	$I_R = 100 \mu A$		30			V
V _F	T _{amb} = 25°C	BAT 42	I _F = 10 mA		0.35	0.4	V
			I _F = 50 mA		0.5	0.65	
		BAT 43	I _F = 2 mA	0.26		0.33	
			I _F = 15 mA			0.45	
		All	I _F = 100 mA			1	
I _R	T _{amb} = 25°C	V _R = 25V				500	nA
	T _{amb} = 100°C					100	μА

DYNAMIC CHARACTERISTICS

Symbol	Test Conditions			Min.	Тур.	Max.	Unit
С	T _{amb} = 25°C	$V_R = 1V$	f = 1MHz		7		pF
trr	$T_{amb} = 25$ °C $I_{rr} = 1$ mA	$I_F = 10 \text{ mA}$ $R_L = 100 \Omega$	I _R = 10 mA			5	ns
η*	T _{amb} = 25°C F = 45Mhz	$R_L = 50 \text{ K}\Omega$ $V_i = 2V$	$C_L = 300 \text{ pF}$ for BAR 43	80			%

^{*} Detection efficiency.

Figure 1. Forward current versus forward voltage at different temperatures (typical values).

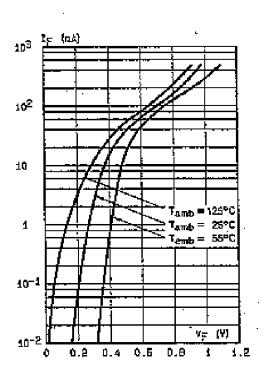


Figure 2. Forward current versus forward voltage (typical values).

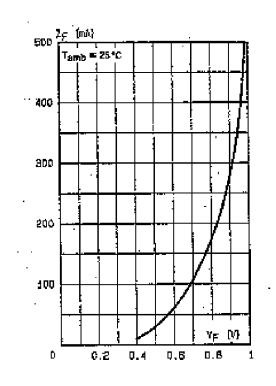
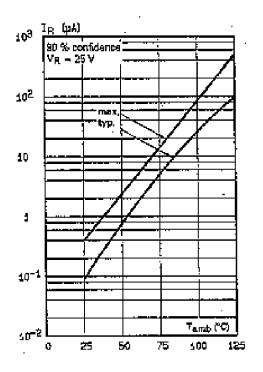


Figure 3. Reverse current versus junction temperature (typical values).

Figure 4. Reverse current versus continuous reverse voltage.



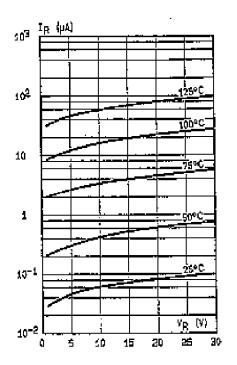
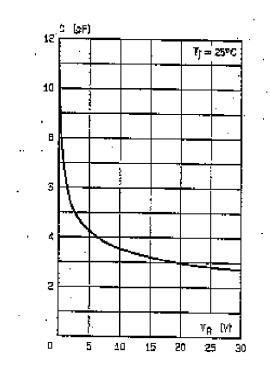


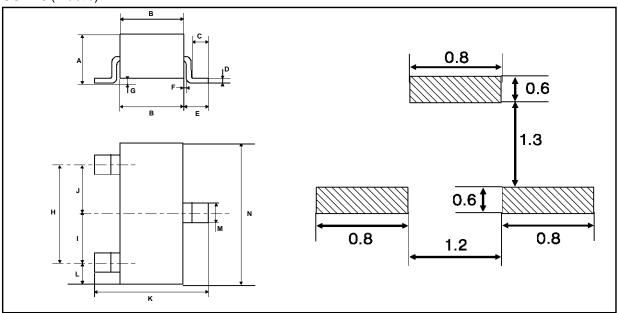
Figure 5. Capacitance C versus reverse applied voltage $V_{\mbox{\scriptsize R}}$ (typical values).



PACKAGE MECHANICAL DATA

FOOT PRINT DIMENSIONS (Millimeter)

SOT 23 (Plastic)



	DIMENSIONS					
REF.	Milli	meters	Inches			
	Min.	Max.	Min.	Max.		
Α	0.93	1.04	0.036	0.041		
В	1.20	1.40	0.047	0.055		
С	0.15		0.006			
D	0.085	0.115	0.003	0.005		
Е	0.45	0.60	0.018	0.024		
F	0.08		0.003			
G	0.013	0.10	0.0005	0.004		
Η	1.90	2.05	0.075	0.081		
	0.95	1.05	0.037	0.041		
J	0.95	1.05	0.037	0.041		
K	2.10	2.50	0.083	0.098		
L	0.45	0.60	0.018	0.024		
М	0.37	0.46	0.015	0.018		
Z	2.80	3.00	0.110	0.118		

Туре	BAR 42	BAR 43	BAR 43A	BAR 43C	BAR 43S
Marking	D94	D95	DB1	DB2	DA5

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